

## N-channel 600 V, 0.076 $\Omega$ typ., 34 A MDmesh™ M2 EP Power MOSFETs in D<sup>2</sup>PAK, TO-220 and TO-247 packages

Datasheet - production data

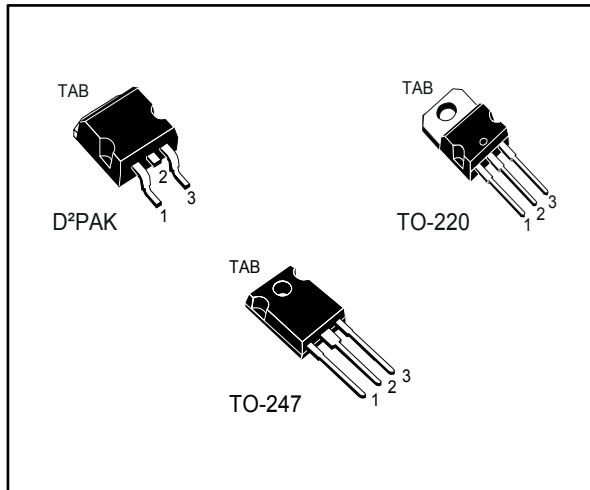
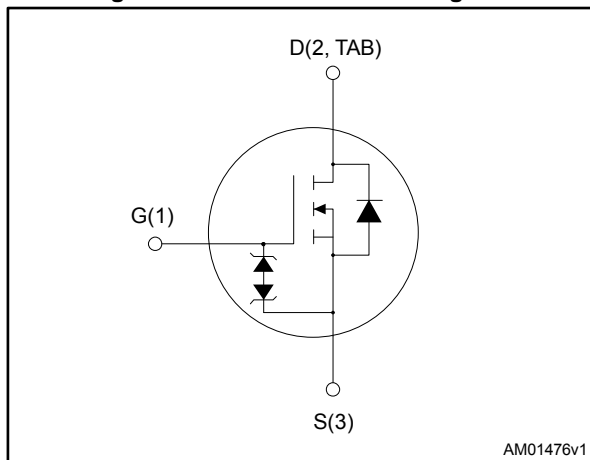


Figure 1: Internal schematic diagram



### Features

| Order code    | V <sub>DS</sub> @ T <sub>Jmax</sub> | R <sub>DS(on)</sub> max. | I <sub>D</sub> |
|---------------|-------------------------------------|--------------------------|----------------|
| STB42N60M2-EP | 650 V                               | 0.087 $\Omega$           | 34 A           |
| STP42N60M2-EP |                                     |                          |                |
| STW42N60M2-EP |                                     |                          |                |

- Extremely low gate charge
- Excellent output capacitance (C<sub>oss</sub>) profile
- Very low turn-off switching losses
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications
- Tailored for very high frequency converters (f > 150 kHz)

### Description

These devices are N-channel Power MOSFETs developed using MDmesh™ M2 EP enhanced performance technology. Thanks to their strip layout and improved vertical structure, the devices exhibit low on-resistance and optimized switching characteristics with very low turn-off switching losses, rendering them suitable for the most demanding very high frequency converters.

Table 1: Device summary

| Order code    | Marking   | Package            | Packing       |
|---------------|-----------|--------------------|---------------|
| STB42N60M2-EP | 42N60M2EP | D <sup>2</sup> PAK | Tape and reel |
| STP42N60M2-EP |           | TO-220             | Tube          |
| STW42N60M2-EP |           | TO-247             |               |

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## Contents

|          |   |           |
|----------|---|-----------|
| <b>1</b> | <b>Electrical ratings .....</b>                                   | <b>3</b>  |
| <b>2</b> | <b>Electrical characteristics .....</b>                           | <b>4</b>  |
|          | 2.1 Electrical characteristics (curves).....                      | 6         |
| <b>3</b> | <b>Test circuits .....</b>  | <b>9</b>  |
| <b>4</b> | <b>Package mechanical data .....</b>                              | <b>10</b> |
|          | 4.1 D <sup>2</sup> PAK (TO-263) type A2 package information ..... | 10        |
|          | 4.2 TO-220 type A package information.....                        | 13        |
|          | 4.3 TO-247 package information.....                               | 15        |
| <b>5</b> | <b>D<sup>2</sup>PAK packing information .....</b>                 | <b>17</b> |
| <b>6</b> | <b>Revision history .....</b>                                     | <b>19</b> |

# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

| Symbol                         | Parameter   | Value       | Unit |
|--------------------------------|---|-------------|------|
| V <sub>GS</sub>                | Gate-source voltage                                   | ± 25        | V    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 25 °C  | 34          | A    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 100 °C | 22          | A    |
| I <sub>DM</sub> <sup>(1)</sup> | Drain current (pulsed)                                | 136         | A    |
| P <sub>TOT</sub>               | Total dissipation at T <sub>C</sub> = 25 °C           | 250         | W    |
| dv/dt <sup>(2)</sup>           | Peak diode recovery voltage slope                     | 15          | V/ns |
| dv/dt <sup>(3)</sup>           | MOSFET dv/dt ruggedness                               | 50          | V/ns |
| T <sub>stg</sub>               | Storage temperature range                             | - 55 to 150 | °C   |
| T <sub>j</sub>                 | Operating junction temperature range                  |             | °C   |

**Notes:**

(1)Pulse width limited by safe operating area.

(2)I<sub>SD</sub> ≤ 34 A, di/dt ≤ 400 A/μs; V<sub>DS(peak)</sub> < V<sub>(BR)DSS</sub>, V<sub>DD</sub> = 400 V.

(3)V<sub>DS</sub> ≤ 480 V

**Table 3: Thermal data**

| Symbol                              | Parameter                           | Value              |        |        | Unit |
|-------------------------------------|-------------------------------------|--------------------|--------|--------|------|
|                                     |                                     | D <sup>2</sup> PAK | TO-220 | TO-247 |      |
| R <sub>thj-case</sub>               | Thermal resistance junction-case    | 0.5                |        |        | °C/W |
| R <sub>thj-pcb</sub> <sup>(1)</sup> | Thermal resistance junction-pcb     | 30                 |        |        | °C/W |
| R <sub>thj-amb</sub>                | Thermal resistance junction-ambient |                    | 62.5   | 50     | °C/W |

**Notes:**

(1)When mounted on FR-4 board of inch<sup>2</sup>, 2oz Cu.

**Table 4: Avalanche characteristics**

| Symbol          | Parameter  | Value | Unit |
|-----------------|--|-------|------|
| I <sub>AR</sub> | Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )                                | 6     | A    |
| E <sub>AS</sub> | Single pulse avalanche energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> ; V <sub>DD</sub> = 50 V) | 800   | mJ   |

## 2 Electrical characteristics

$T_C = 25\text{ °C}$  unless otherwise specified

**Table 5: On/off states**

| Symbol        | Parameter                         | Test conditions  | Min. | Typ.  | Max.     | Unit          |
|---------------|-----------------------------------|--|------|-------|----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage    | $V_{GS} = 0\text{ V}$ , $I_D = 1\text{ mA}$                                      | 600  |       |          | V             |
| $I_{DSS}$     | Zero gate voltage Drain current   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$                                  |      |       | 1        | $\mu\text{A}$ |
|               |                                   | $V_{GS} = 0\text{ V}$ , $V_{DS} = 600\text{ V}$ ,<br>$T_C = 125\text{ °C}^{(1)}$ |      |       | 100      | $\mu\text{A}$ |
| $I_{GSS}$     | Gate-body leakage current         | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 25\text{ V}$                               |      |       | $\pm 10$ | $\mu\text{A}$ |
| $V_{GS(th)}$  | Gate threshold voltage            | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                               | 2    | 3     | 4        | V             |
| $R_{DS(on)}$  | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$ , $I_D = 17\text{ A}$                                     |      | 0.076 | 0.087    | $\Omega$      |

**Notes:**

<sup>(1)</sup>Defined by design, not subject to production test

**Table 6: Dynamic**

| Symbol               | Parameter                     | Test conditions  | Min. | Typ. | Max. | Unit     |
|----------------------|-------------------------------|--|------|------|------|----------|
| $C_{iss}$            | Input capacitance             | $V_{DS} = 100\text{ V}$ , $f = 1\text{ MHz}$ ,<br>$V_{GS} = 0\text{ V}$  | -    | 2370 | -    | pF       |
| $C_{oss}$            | Output capacitance            |  | -    | 112  | -    | pF       |
| $C_{rss}$            | Reverse transfer capacitance  |  | -    | 2.5  | -    | pF       |
| $C_{oss\ eq.}^{(1)}$ | Equivalent output capacitance | $V_{DS} = 0\text{ to }480\text{ V}$ , $V_{GS} = 0\text{ V}$  | -    | 454  | -    | pF       |
| $R_G$                | Intrinsic gate resistance     | $f = 1\text{ MHz}$ , $I_D = 0\text{ A}$  | -    | 4.5  | -    | $\Omega$ |
| $Q_g$                | Total gate charge             | $V_{DD} = 480\text{ V}$ , $I_D = 34\text{ A}$ ,<br>$V_{GS} = 0\text{ to }10\text{ V}$<br>(see <a href="#">Figure 18: "Test circuit for gate charge behavior"</a> ) | -    | 55   | -    | nC       |
| $Q_{gs}$             | Gate-source charge            |  | -    | 8.5  | -    | nC       |
| $Q_{gd}$             | Gate-drain charge             |  | -    | 25   | -    | nC       |

**Notes:**

<sup>(1)</sup> $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$

**Table 7: Switching energy**

| Symbol      | Parameter   | Test conditions  | Min. | Typ. | Max. | Unit          |
|-------------|---|--|------|------|------|---------------|
| $E_{(off)}$ | Turn-off energy<br>(from 90% $V_{GS}$ to 0% $I_D$ ) | $V_{DD} = 400\text{ V}$ , $I_D = 2.5\text{ A}$ ,<br>$R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$ | -    | 13   | -    | $\mu\text{J}$ |
|             |   | $V_{DD} = 400\text{ V}$ , $I_D = 5\text{ A}$ ,<br>$R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$   | -    | 14.5 | -    | $\mu\text{J}$ |

Table 8: Switching times

| Symbol       | Parameter           | Test conditions  | Min. | Typ. | Max. | Unit |
|--------------|---------------------|--|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 300\text{ V}$ , $I_D = 17\text{ A}$ ,<br>$R_G = 4.7\ \Omega$ , $V_{GS} = 10\text{ V}$<br>(see <a href="#">Figure 17: "Test circuit for resistive load switching times"</a> and<br><a href="#">Figure 22: "Switching time waveform"</a> ) | -    | 16.5 | -    | ns   |
| $t_r$        | Rise time           |  | -    | 9.5  | -    | ns   |
| $t_{d(off)}$ | Turn-off-delay time |  | -    | 96.5 | -    | ns   |
| $t_f$        | Fall time           |  | -    | 8    | -    | ns   |

Table 9: Source drain diode

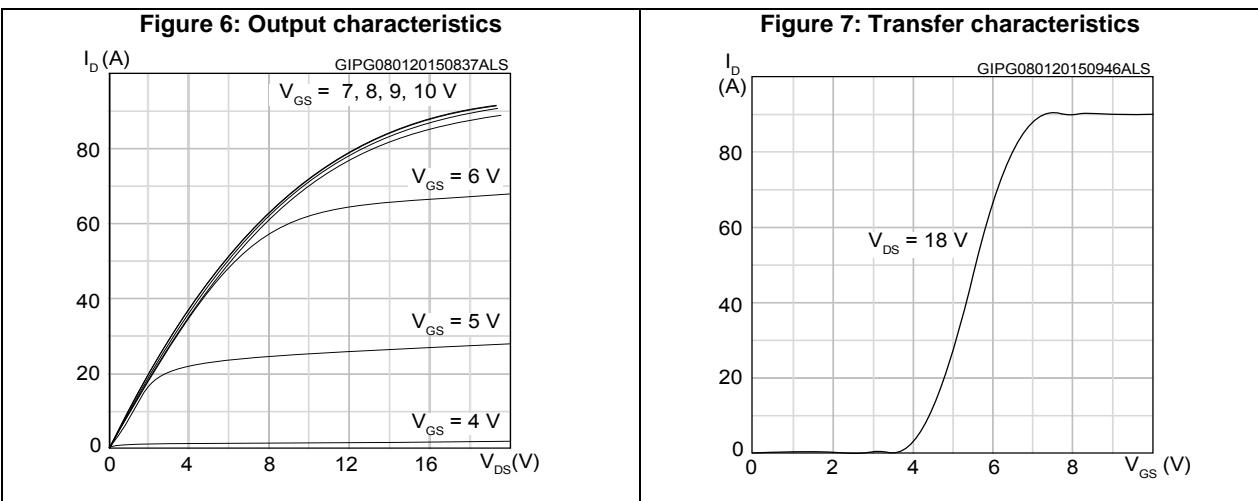
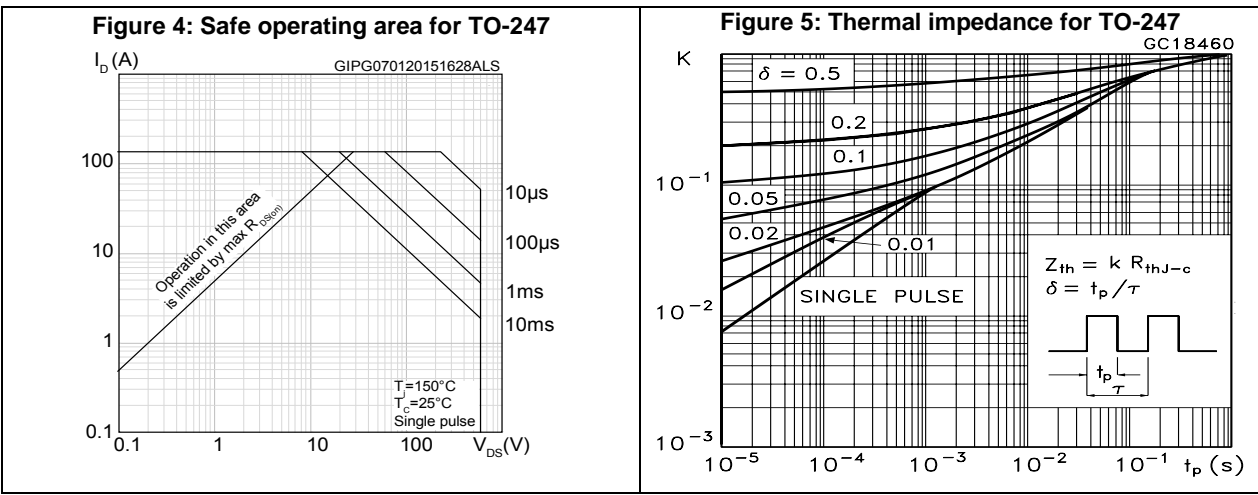
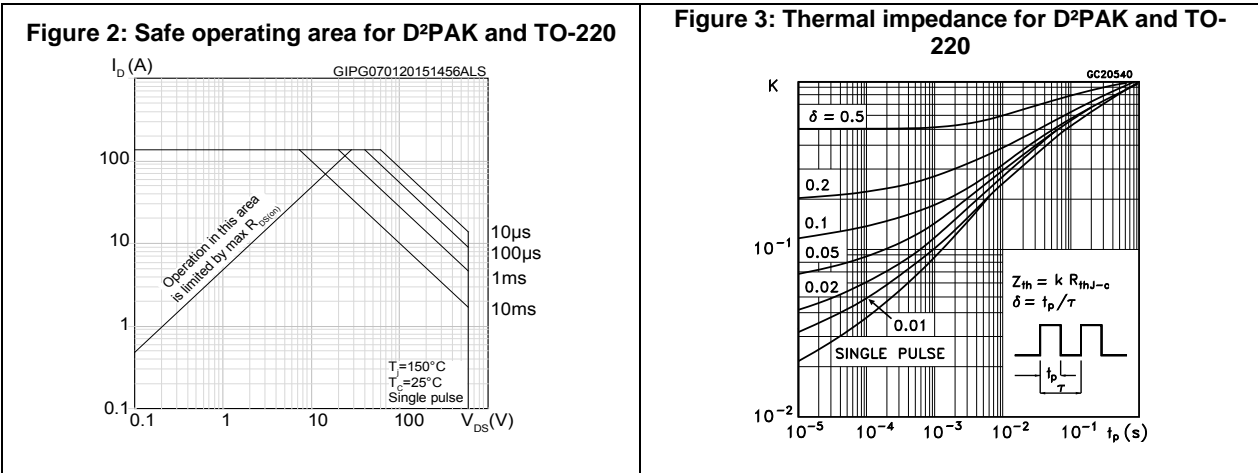
| Symbol          | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|---|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |   | -    |      | 34   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |   | -    |      | 136  | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $V_{GS} = 0\text{ V}$ , $I_{SD} = 34\text{ A}$  | -    |      | 1.6  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 34\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 60\text{ V}$<br>(see <a href="#">Figure 19: "Test circuit for inductive load switching and diode recovery times"</a> )                                     | -    | 438  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |   | -    | 9    |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |   | -    | 41.5 |      | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 34\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 60\text{ V}$ , $T_j = 150\text{ }^\circ\text{C}$<br>(see <a href="#">Figure 19: "Test circuit for inductive load switching and diode recovery times"</a> ) | -    | 538  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |   | -    | 12   |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |   | -    | 44.5 |      | A             |

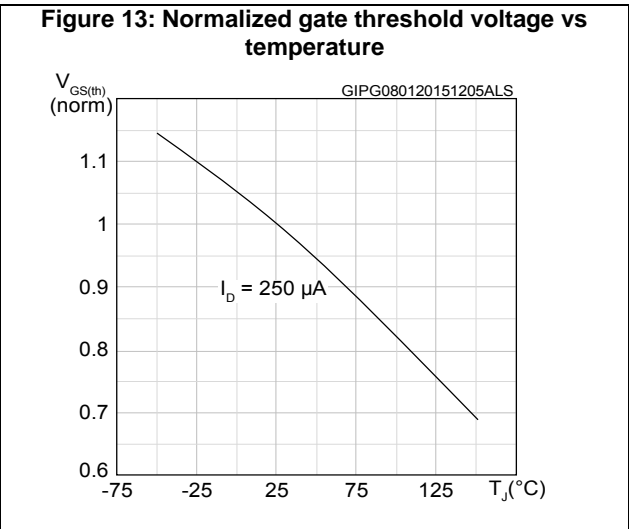
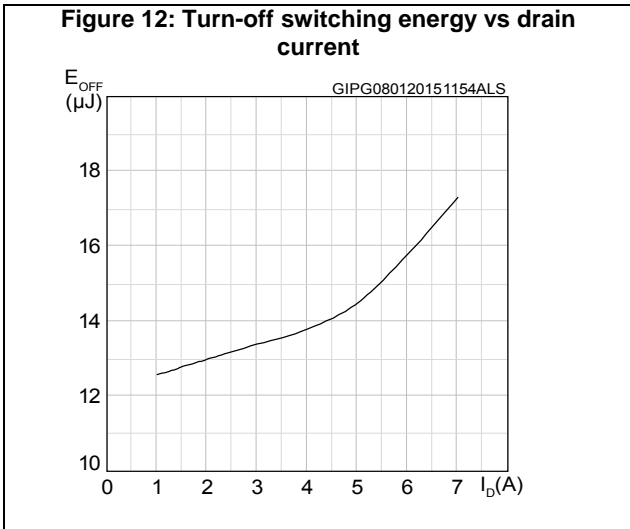
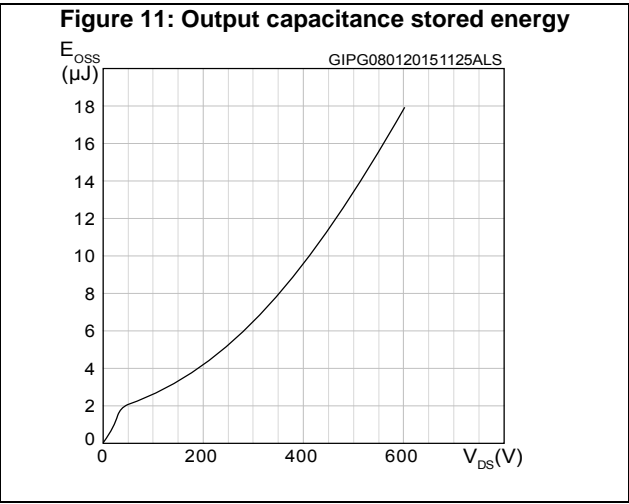
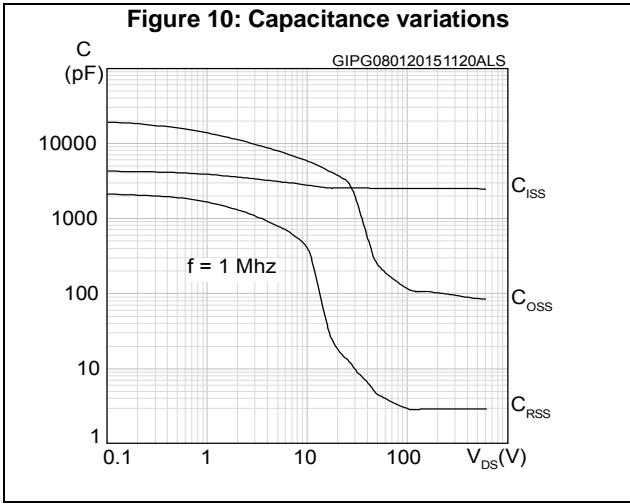
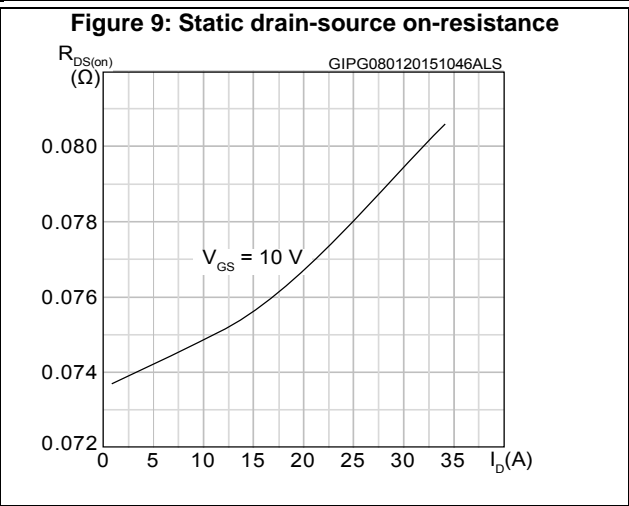
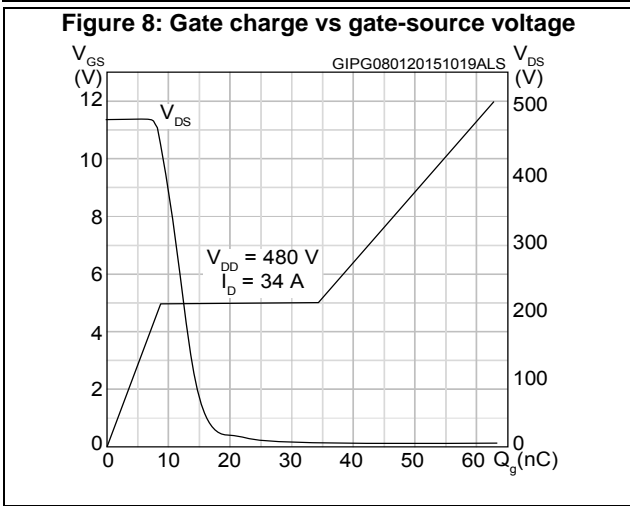
**Notes:**

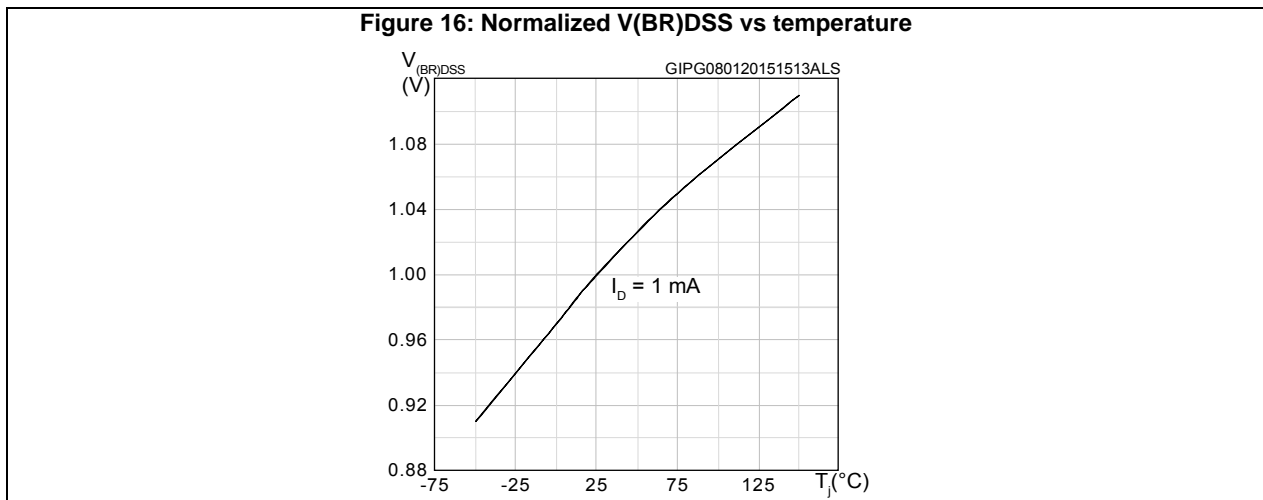
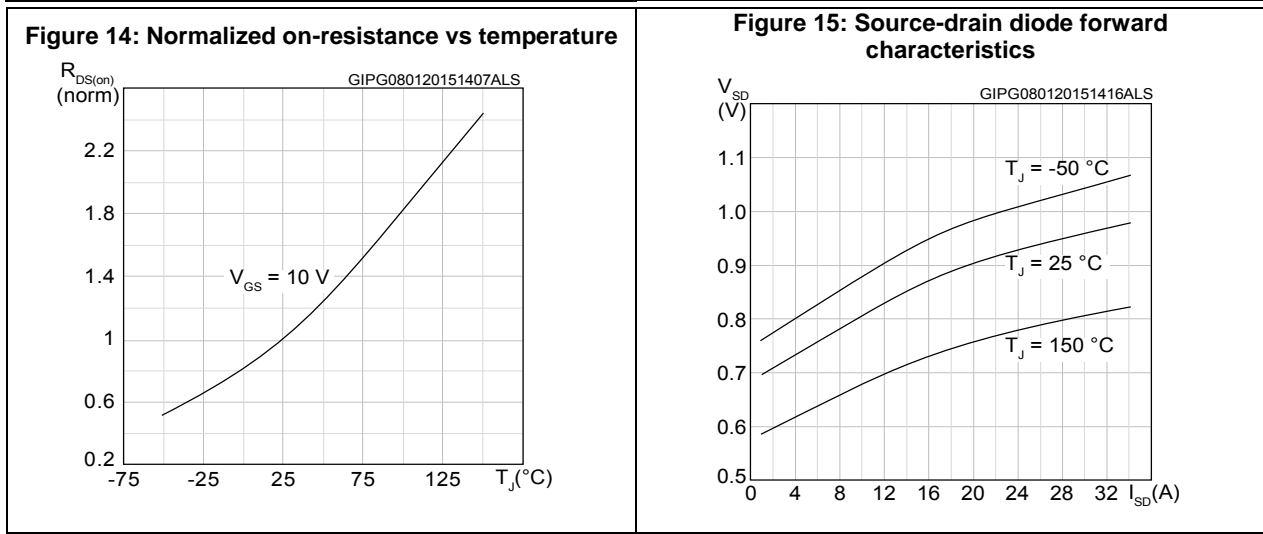
(1)Pulse width is limited by safe operating area

(2)Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)



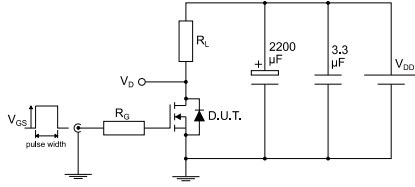






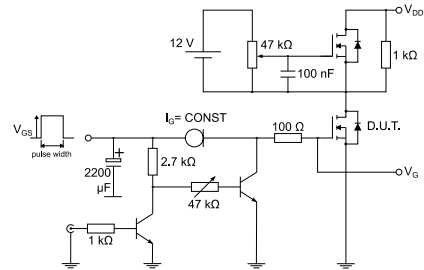
### 3 Test circuits

**Figure 17: Test circuit for resistive load switching times**



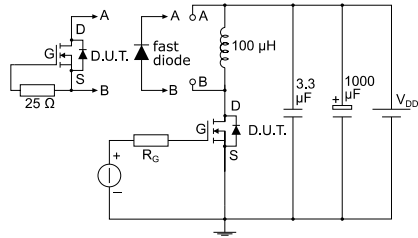
AM0148b1

**Figure 18: Test circuit for gate charge behavior**



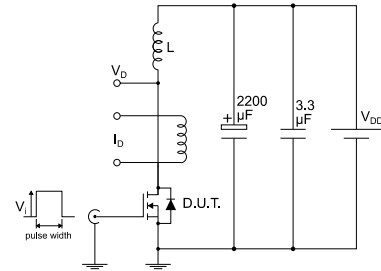
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**Figure 19: Test circuit for inductive load switching and diode recovery times**



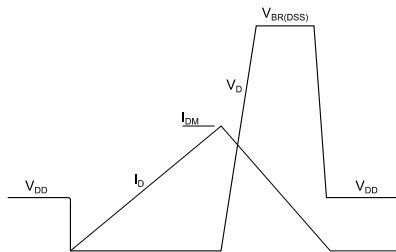
AM01470v1

**Figure 20: Unclamped inductive load test circuit**



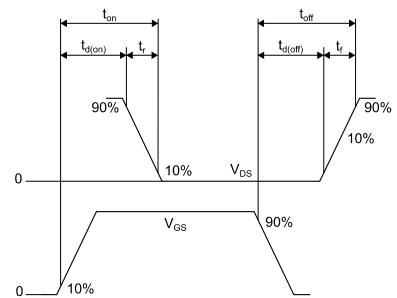
AM01471v1

**Figure 21: Unclamped inductive waveform**



AM01472v1

**Figure 22: Switching time waveform**



AM01473v1

## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 D<sup>2</sup>PAK (TO-263) type A2 package information

Figure 23: D<sup>2</sup>PAK (TO-263) type A2 package outline

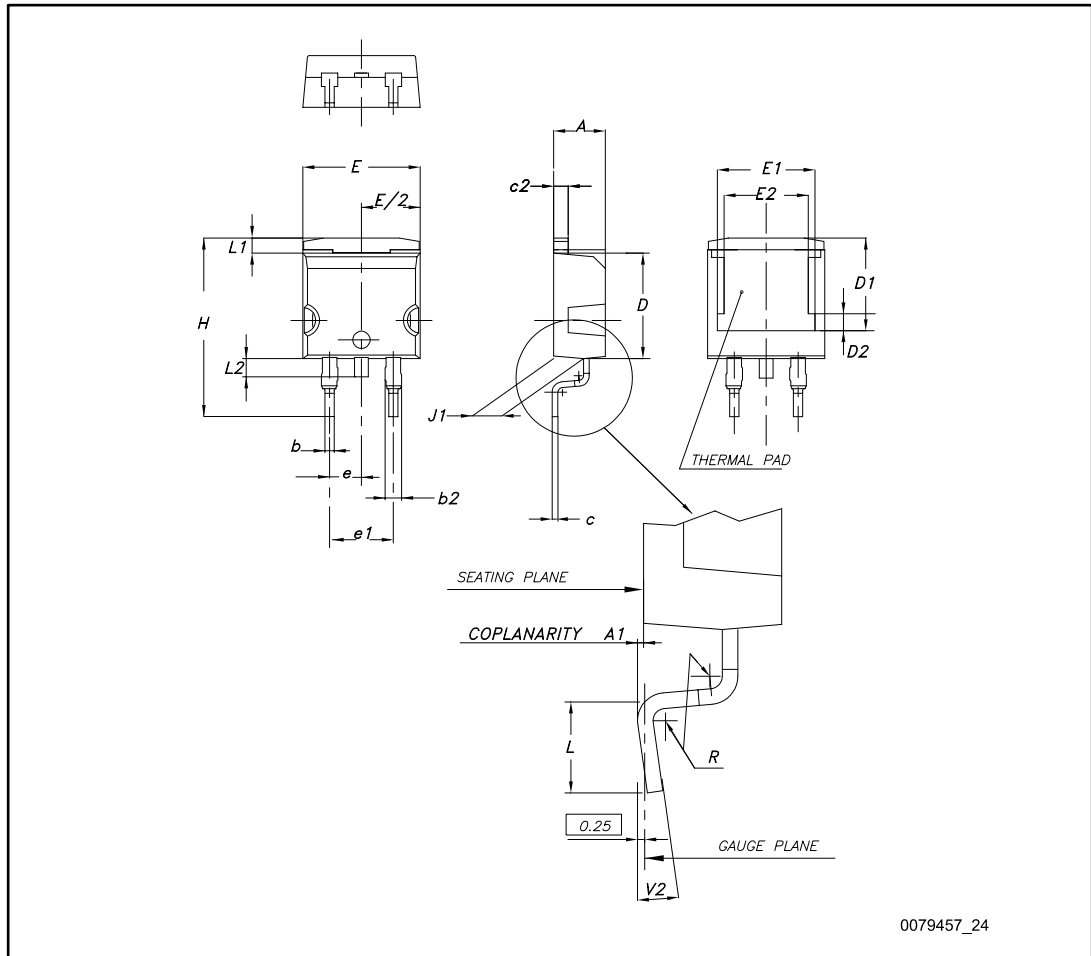
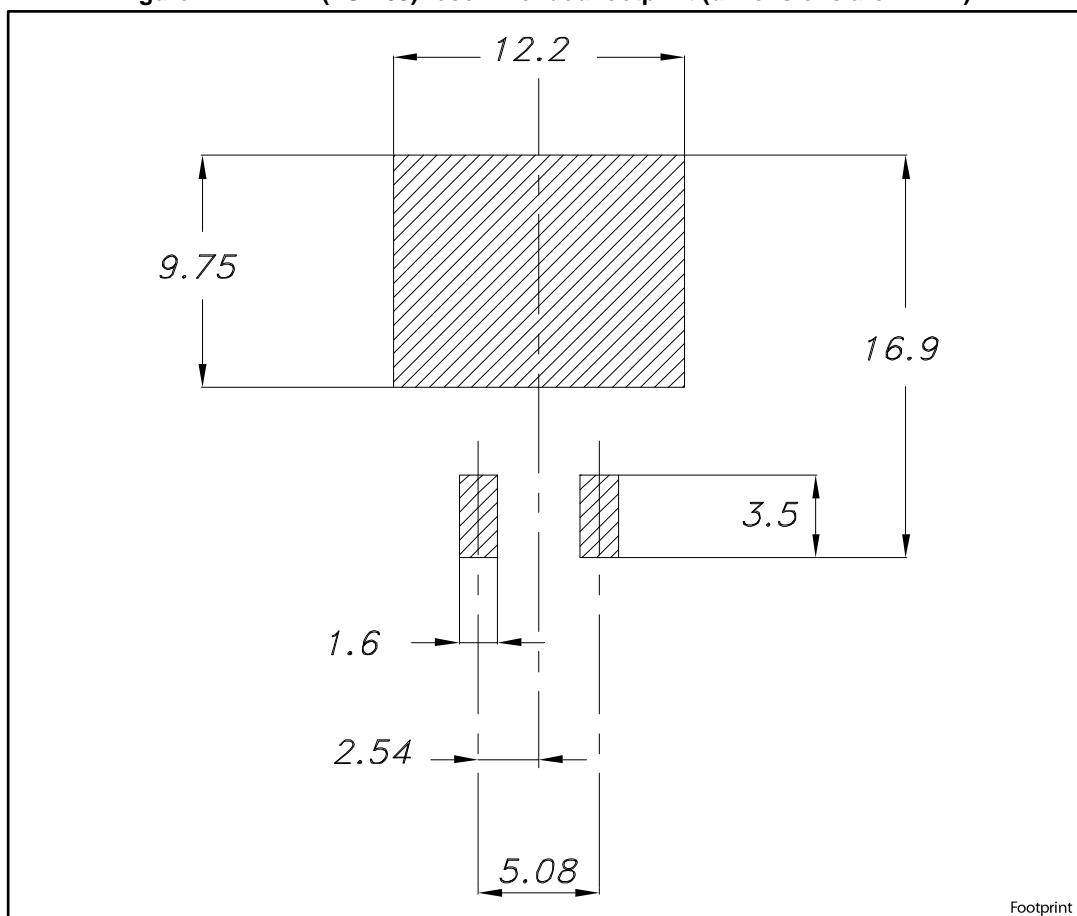


Table 10: D<sup>2</sup>PAK (TO-263) type A2 package mechanical data

| Dim. | mm    |      |       |
|------|-------|------|-------|
|      | Min.  | Typ. | Max.  |
| A    | 4.40  |      | 4.60  |
| A1   | 0.03  |      | 0.23  |
| b    | 0.70  |      | 0.93  |
| b2   | 1.14  |      | 1.70  |
| c    | 0.45  |      | 0.60  |
| c2   | 1.23  |      | 1.36  |
| D    | 8.95  |      | 9.35  |
| D1   | 7.50  | 7.75 | 8.00  |
| D2   | 1.10  | 1.30 | 1.50  |
| E    | 10.00 |      | 10.40 |
| E1   | 8.70  | 8.90 | 9.10  |
| E2   | 7.30  | 7.50 | 7.70  |
| e    |       | 2.54 |       |
| e1   | 4.88  |      | 5.28  |
| H    | 15.00 |      | 15.85 |
| J1   | 2.49  |      | 2.69  |
| L    | 2.29  |      | 2.79  |
| L1   | 1.27  |      | 1.40  |
| L2   | 1.30  |      | 1.75  |
| R    |       | 0.40 |       |
| V2   | 0°    |      | 8°    |

Figure 24: D<sup>2</sup>PAK (TO-263) recommended footprint (dimensions are in mm)



## 4.2 TO-220 type A package information

Figure 25: TO-220 type A package outline

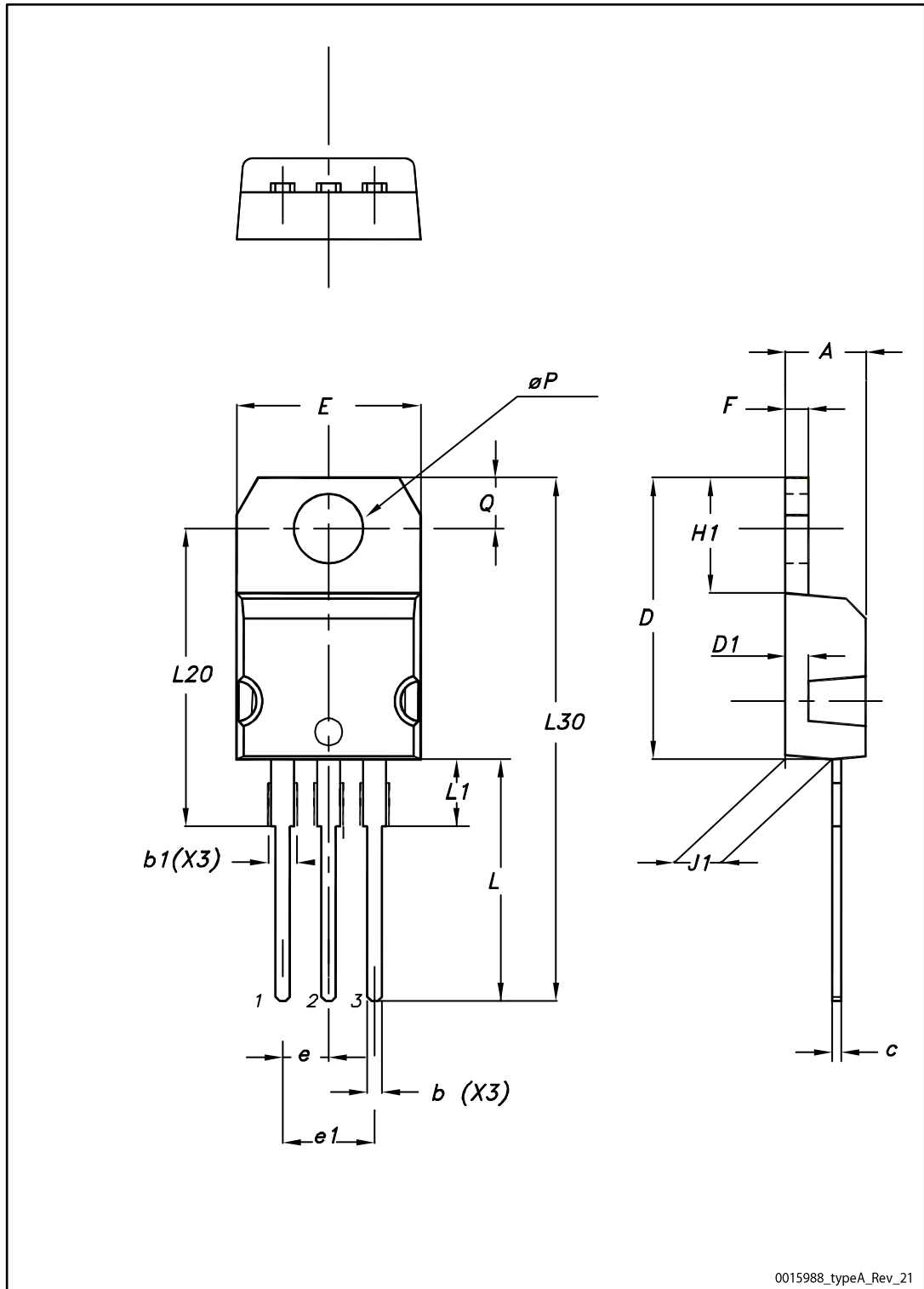


Table 11: TO-220 type A package mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.40  |       | 4.60  |
| b    | 0.61  |       | 0.88  |
| b1   | 1.14  |       | 1.55  |
| c    | 0.48  |       | 0.70  |
| D    | 15.25 |       | 15.75 |
| D1   |       | 1.27  |       |
| E    | 10.00 |       | 10.40 |
| e    | 2.40  |       | 2.70  |
| e1   | 4.95  |       | 5.15  |
| F    | 1.23  |       | 1.32  |
| H1   | 6.20  |       | 6.60  |
| J1   | 2.40  |       | 2.72  |
| L    | 13.00 |       | 14.00 |
| L1   | 3.50  |       | 3.93  |
| L20  |       | 16.40 |       |
| L30  |       | 28.90 |       |
| øP   | 3.75  |       | 3.85  |
| Q    | 2.65  |       | 2.95  |

### 4.3 TO-247 package information

Figure 26: TO-247 package outline

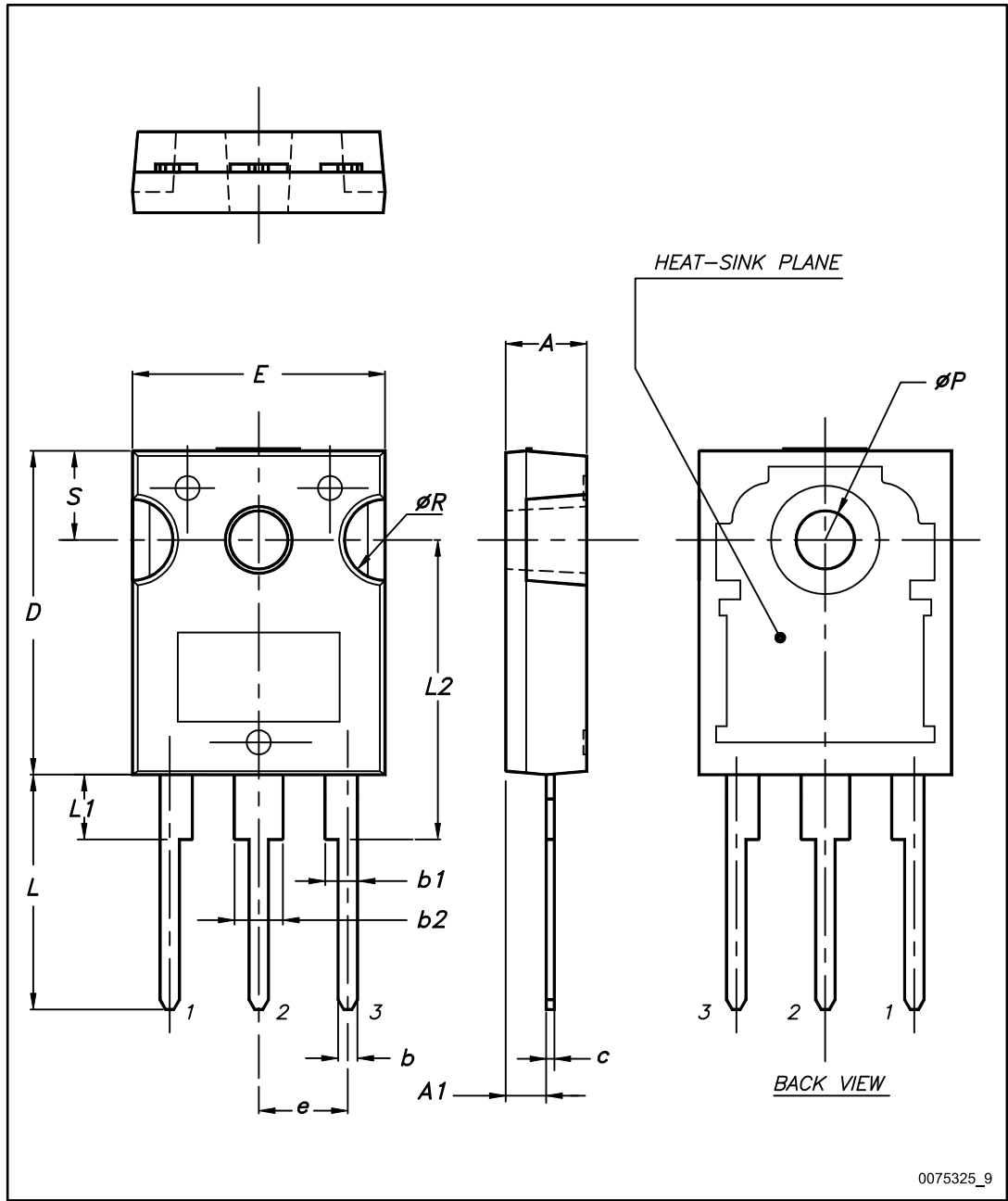


Table 12: TO-247 package mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.85  |       | 5.15  |
| A1   | 2.20  |       | 2.60  |
| b    | 1.0   |       | 1.40  |
| b1   | 2.0   |       | 2.40  |
| b2   | 3.0   |       | 3.40  |
| c    | 0.40  |       | 0.80  |
| D    | 19.85 |       | 20.15 |
| E    | 15.45 |       | 15.75 |
| e    | 5.30  | 5.45  | 5.60  |
| L    | 14.20 |       | 14.80 |
| L1   | 3.70  |       | 4.30  |
| L2   |       | 18.50 |       |
| ØP   | 3.55  |       | 3.65  |
| ØR   | 4.50  |       | 5.50  |
| S    | 5.30  | 5.50  | 5.70  |



## 5 D<sup>2</sup>PAK packing information

Figure 27: D<sup>2</sup>PAK tape outline

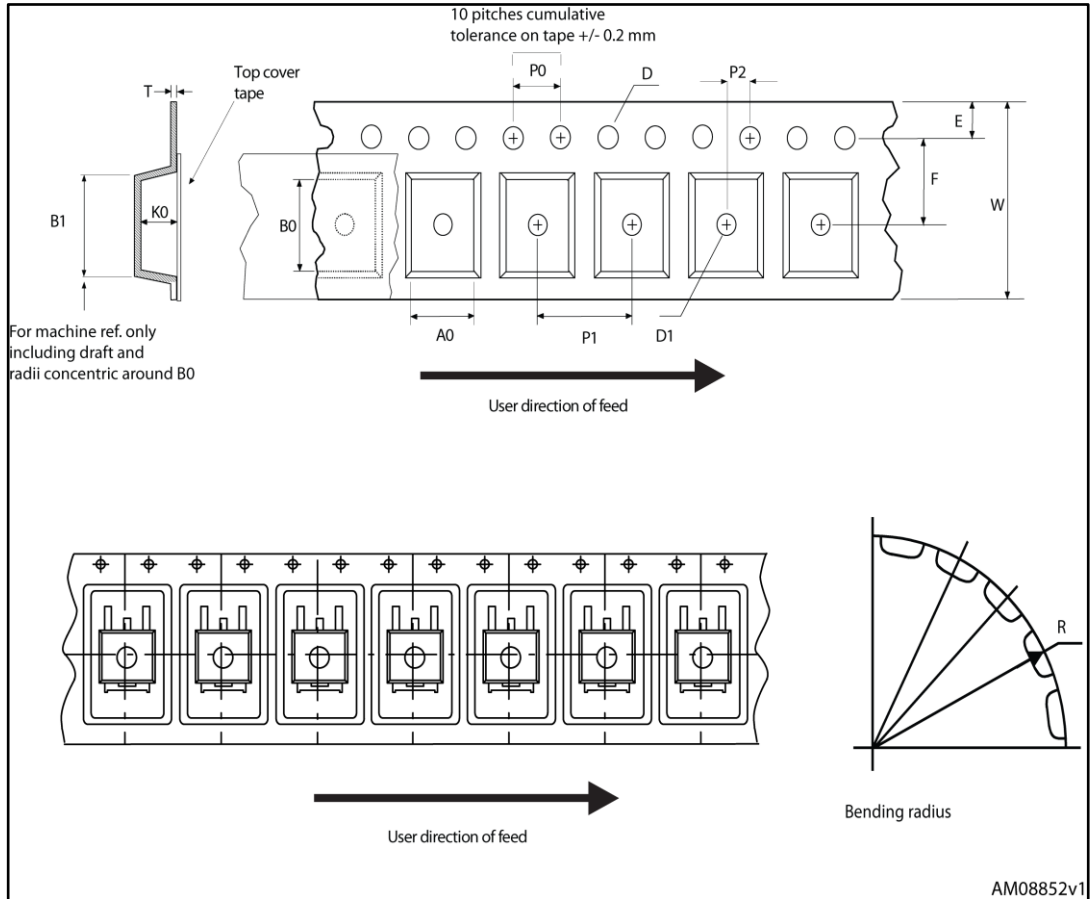


Figure 28: D<sup>2</sup>PAK reel outline

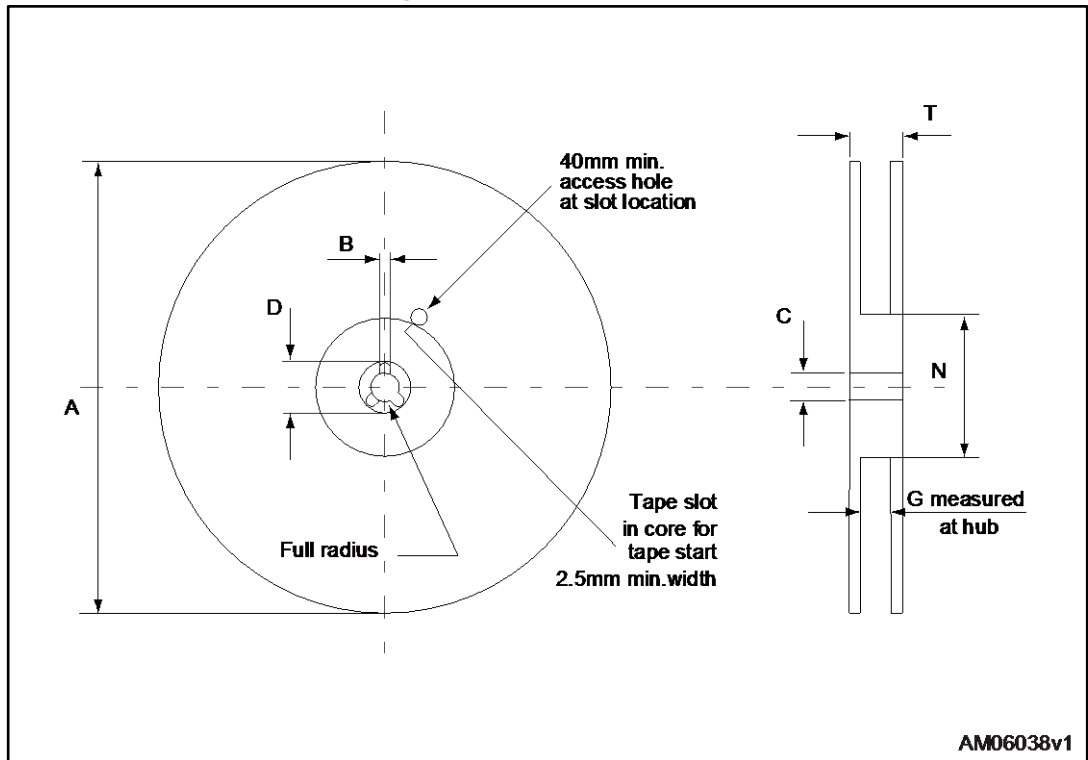


Table 13: D<sup>2</sup>PAK tape and reel mechanical data

| Tape |      |      | Reel          |      |      |
|------|------|------|---------------|------|------|
| Dim. | mm   |      | Dim.          | mm   |      |
|      | Min. | Max. |               | Min. | Max. |
| A0   | 10.5 | 10.7 | A             |      | 330  |
| B0   | 15.7 | 15.9 | B             | 1.5  |      |
| D    | 1.5  | 1.6  | C             | 12.8 | 13.2 |
| D1   | 1.59 | 1.61 | D             | 20.2 |      |
| E    | 1.65 | 1.85 | G             | 24.4 | 26.4 |
| F    | 11.4 | 11.6 | N             | 100  |      |
| K0   | 4.8  | 5.0  | T             |      | 30.4 |
| P0   | 3.9  | 4.1  |               |      |      |
| P1   | 11.9 | 12.1 | Base quantity |      | 1000 |
| P2   | 1.9  | 2.1  | Bulk quantity |      | 1000 |
| R    | 50   |      |               |      |      |
| T    | 0.25 | 0.35 |               |      |      |
| W    | 23.7 | 24.3 |               |      |      |

## 6 Revision history

Table 14: Document revision history

| Date        | Revision | Changes   |
|-------------|----------|---|
| 20-Jan-2015 | 1        | First release.  |
| 03-Nov-2017 | 2        | Updated <i>Section 4.1: "D<sup>2</sup>PAK (TO-263) type A2 package information"</i> and <i>Section 5: "D<sup>2</sup>PAK packing information"</i><br>Minor text changes. |

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